



Surface-mount Ceramic Multilayer Capacitors (RoHS compliant & Halogen Free)

CC0603KRX7R7BB104

(0603,X7R, 100nF, 16V, ±10%)

Spec Sheet

Scope

This product specification is applied to Multi-layer Ceramic Capacitor used for General Electronic equiments.

Yageo Part Number



0603

(2) Cap Tol

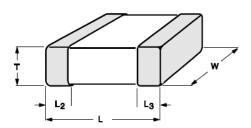
R
(3) Packaging

X7R

7
(5) Rated Volt.

BB

(6) Capacitano



(1) External Dimensions

(Unit: mm)

L	1.6±0.1
W	0.8±0.1
Т	0.8±0.1
L2/L3	0.20 to 0.60

(2) Capacitance Tolerance:	±10%
(4) Temperature Characteristics:	X7R
Temperature Range:	-55 to 125 $^{\circ}\mathrm{C}$
Cap Change:	±15%
(5) Rated Voltage:	16V
(6) Capacitance:	100nF
(3) Package:	Paper Tape Reel 7"
Packaging Unit:	4,000 pcs
Resistance:	R x C > 500Ω.F
Dielectric Loss Tangent:	3.5%
RoHS Compliance:	Yes
Halogen Free:	Yes
Soldering Method:	Reflow/Wave





IEC-60384 Standard Specification and Test methods

Test Item	Procedure	Requirements
Mounting	The capacitors may be mounted on printed-circuit boards or	No visible damage
	ceramic substrates.	
Visual inspection and	Any applicable method using x10 magnification	In accordance with specification
dimension check		
Capacitance	Class1:	Within specified tolerance
	C ≤1nF, f = 1 MHz;	
Dielectric loss tangent	C > 1nF, f = 1 KHz;	
	NPO: measuring voltage 1 V at room temp.	
	Class 2 (X5R, X6S, X7R, Y5V) :	
	Precondition:	
	150 +0/-10 $^{\circ}\text{C}$ /1 hr , then keep for 24±1 hrs at room temp.	
	f = 1 KHz; measuring voltage 1 V at room temp.	
Insulation resistance	At Ur (DC) for 1 minute at room temp.	In accordance with specification
	Ur(DC) > 500V: At 500V for 1 minute	
Temperature coefficient	Capacitance shall be measured by the steps shown in the	Class I:
	following table.	Δ C/C: ±30ppm
	The capacitance change should be measured after 5 min at	
	each specified temperature stage.	Class II:
	Step Temperature	X7R/ X5R: Δ C/C: ±15%
	a 25±2	Y5V: ∆ C/C: +22~-82%
	b Lower Temperature ±3	
	c 25±2	
	d Upper Temperature ±2	
	e 25±2	
	(1) Class I	
	Temperature Coefficient shall be calculated from the formula	
	as below:	
	Temp, Coefficient = $\frac{\text{C2 - C1}}{\text{C1} \times \triangle \text{T}} \times 10^6 \text{ [ppm/C]}$	
	C1: Capacitance at step c	
	C2: Capacitance at 125°C	
	∆T: 100°C (=125°C -25°C)	
	(2) Class II	
	Capacitance Change shall be calculated from the formula	
	as below.	
	$\triangle C = \frac{C2 - C1}{C1} \times 100(\%)$	
	C1: Capacitance at step c	
	C2: Capacitance at step b or d	





IEC-60384 Standard Specification and Test methods

Test Item	Procedure	Requirements
Adhesion	A force applied for 10 sec to the line joining the terminations	Force:
	and in a plane parallel to the substrate.	size≧0603: ≥5N, size=0402: ≥2.5N, size≤0201: ≥1N
Bending Strength	Mounting in accordance with IEC 60384-22 paragraph 4.3	No visible damage
	Conditions: bending 1 mm at a rate of 1 mm/s,	Δ C/C: Class I, within ±1% or 0.5 pF, whichever is greater
	radius jig 5mm.	Class II: X7R, X5R:±10%, Y5V: ±20%
Resistance to soldering heat	Precondition:	Dissolution of the end face plating shall not exceed 25%
	150 +0/-10°C/1 hr, then keep for 24±1 hrs at room temp	of the length of the edge concerned.
	Preheating: for size >1206:100 to 120 °C for 1 minute and	Δ C/C:
	170 to 200°C for 1 minute.	Class I, within ±0.5% or 0.5 pF, whichever is greater
	Solder bath temperature: 260 ± 5°C	Class II: X7R, X5R:±10%, Y5V: ±20%
	Dipping time 10±0.5 s	DF: within initial specified value
	Recovery time 24±2 Hours.	IR: within initial specified value
Solderability	The specimen shall be preheated to a temperature of	The solder should cover over 95% of the critical area
	80 to 140 $^{\circ}\mathrm{C}$ and maintained for 30s to 60s.	of each termination.
	1. Temperature: 235±5°C / Dipping time: 2 ±0.5 s	
	2. Temperature: 245±5°C / Dipping time: 3 ±0.5 s (lead free)	
	Depth of immersion: 10mm	
Rapid change of temperature	Precondition:	No visual damage
	150 +0/-10 ℃ /1 hr, then keep for 24±1 hrs at room temp	Δ C/C:
	5 cycles with following detail:	Class I, within ±1% or 1 pF, whichever is greater
	30 minutes at Lower Category Temperature;	Class II: X7R, X5R:±15%, Y5V: ±20%
	30 minutes at Upper Category Temperature;	DF: within initial specified value
	Recovery time 24±2 Hours.	IR: within initial specified value
Damp heat with Ur load	1. Precondition (Class II only):	No visual damage after recovery
	150 +0/-10 ℃ /1 hr, then keep for 24±1 hrs at room temp	Δ C/C:
	2. Initial measure	Class I, within ±2% or 1 pF, whichever is greater
	Spec: refer Initial spec (Cap, DF, IR)	Class II: X7R, X5R:±15%, Y5V: ±30%
	3. Damp heat test:	DF:
	500±12 hours at 40±2°C; 90 to 95% R.H.; 1.0Ur applied	Class I: 2 x specified value
	4. Recovery:	Class II:
	Class 1: 6 to 24 hours, Class 2: 24±2 hours	X7R/X5R:
	5. Final measure:	≤16V: ≤7% or 2 x specified value whichever is greater
	Cap, DF, IR	≥25V: ≤5% or 2 x specified value whichever is greater
		Y5V : ≤15%
	P.S. If the capacitance value is less than the minimum value	IR:
	permitted, then after the other measurements have been made	Class I:
	the capacitor shall be precondition according to IEC 60384 4.1	\ge 2,500MΩ or RxC \ge 25Ω.F whichever is less
	and then the requirement shall be met.	Class II:
		\ge 500MΩ or RxC \ge 25Ω.F whichever is less





IEC-60384 Standard Specification and Test methods

Test Item	Procedure	Requirements
Endurance	1. Precondition (Class II only):	No visual damage after recovery
	150 +0/-10 $^{\circ}\text{C}$ /1 hr, then keep for 24±1 hrs at room temp	Δ C/C:
	2. Initial measure	Class I, within ±2% or 1 pF, whichever is greater
	Spec: refer Initial spec (Cap, DF, IR)	Class II: X7R, X5R:±15%, Y5V: ±30%
	3. Endurance test:	DF:
	Temperature: NPO/X7R: 125° $\mathbb C$, X5R/Y5V: 85° $\mathbb C$	Class I: 2 x specified value
	Specified voltage applied for 1000 hrs	Class II:
	Applied 150% Ur for 4V to 250V series	X7R/X5R:
	Applied 130% Ur for 500V/630V series	≤16V: ≤7% or 2 x specified value whichever is greater
	Applied 120% Ur for 1000V and above series	≥25V: ≤5% or 2 x specified value whichever is greater
	Recovery time: 24±2 hours	Y5V : ≤15%
	5. Final measure:	
	Cap, DF, IR	IR:
		Class I:
		\ge 4,000MΩ or RxC \ge 40Ω.F whichever is less
	P.S. If the capacitance value is less than the minimum value	Class II:
	permitted, then after the other measurements have been made	$e \ge 1000 M\Omega$ or RxC $\ge 50 \Omega$.F whichever is less
	the capacitor shall be precondition according to IEC 60384 4.1	
	and then the requirement shall be met.	
Voltage Proof	Specified stress voltage applied for 1 ~5 sec.	No breakdown or flashover
	Ur ≤ 100 V: series applied 2.5 Ur	
	100 V < Ur ≤ 200 V series applied (1.5 Ur + 100)	
	200 V < Ur ≤ 500 V series applied (1.3 Ur + 100)	
	Ur = 630 V: 1.3 Ur	
	Ur ≥ 1000 V: 1.2 Ur	
	Charge / Discharge current less than 50mA.	

Shelf Life & Storage Condition

According with international specification JIS 1997.

(1) Storage Condtions: Temperature -5 to 40°C

Relative humidity 40~85%

(2) Shelf Life: 2 years from date of manufacture

We recommend that the products are stored in their original packing (e.g. tape, reel).

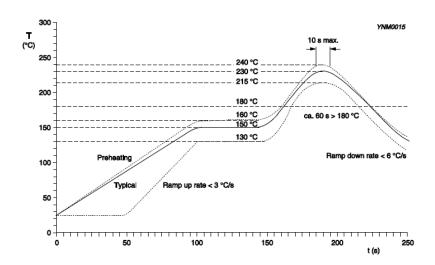
They should never be touched by hand.





Soldering Condition

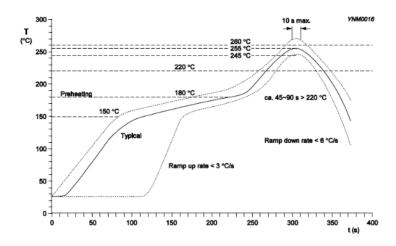
For normal use the capacitors may be mounted on printed-circuit boards or ceramic substrates by applying wave soldering, reflow soldering or conductive adhesive in accordance with "IEC 61760-1" (Standard method for the specification of surface mounting components).



Solid line: Typical process (terminal temperature)

Dotted lines: Process limits - bottom process limit (terminal temperature) & upper process limit (top surface temperature).

Infrared soldering, forced gas convection reflow soldering - Temperature/time profile for SnPb solders

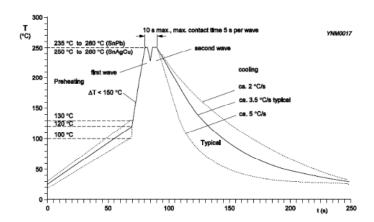


Solid line: Typical process (terminal temperature)

Dotted lines: Process limits - bottom process limit (terminal temperature) & upper process limit (top surface temperature).

Infrared soldering, forced gas convection reflow soldering - Temperature/time profile for lead-free SnAgCu solders





Solid line: Typical process Dotted lines: Process limits

Double wave soldering for SnPb and lead-free SnAgCu solder - Temperature/time profile (terminal temperature)